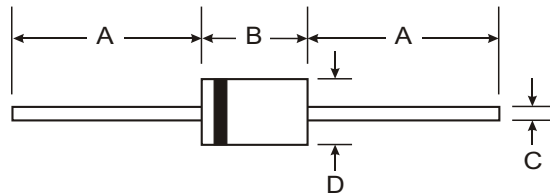


### Features

- Glass Passivated Die Construction
- Diffused Junction
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 30A Peak
- Plastic Material - UL Flammability Classification 94V-0



### Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: DO-41 0.30 grams (approx)  
A-405 0.20 grams (approx)
- Mounting Position: Any
- Marking: Type Number

Dim	DO-41 Plastic		A-405	
	Min	Max	Min	Max
A	25.40	—	25.40	—
B	4.06	5.21	4.10	5.20
C	0.71	0.864	0.53	0.64
D	2.00	2.72	2.00	2.70

**All Dimensions in mm**

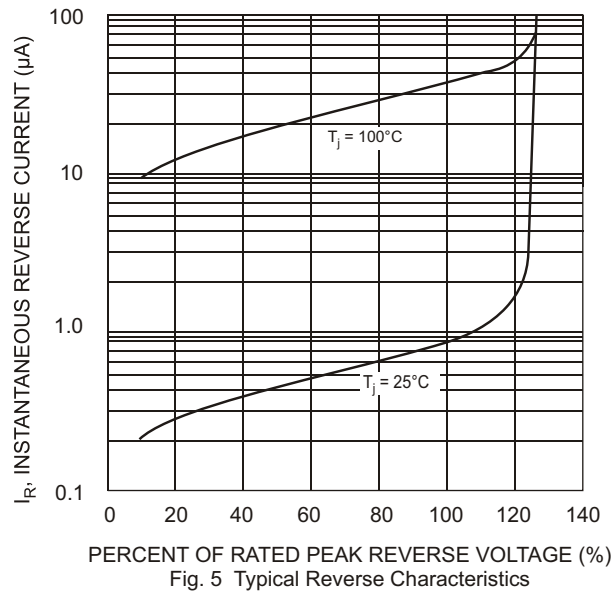
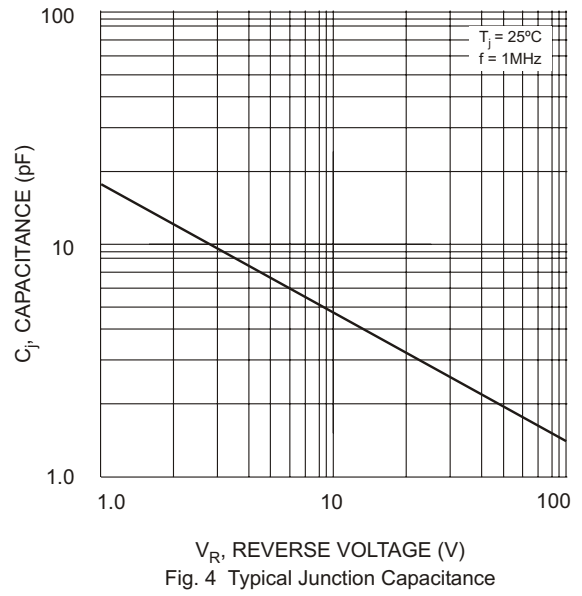
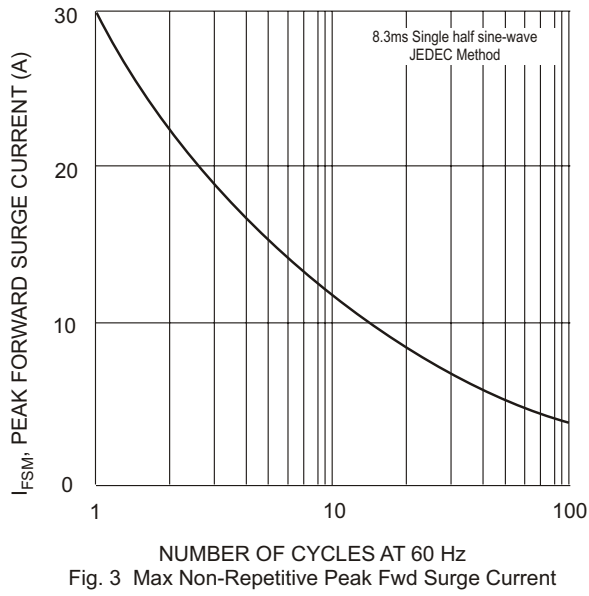
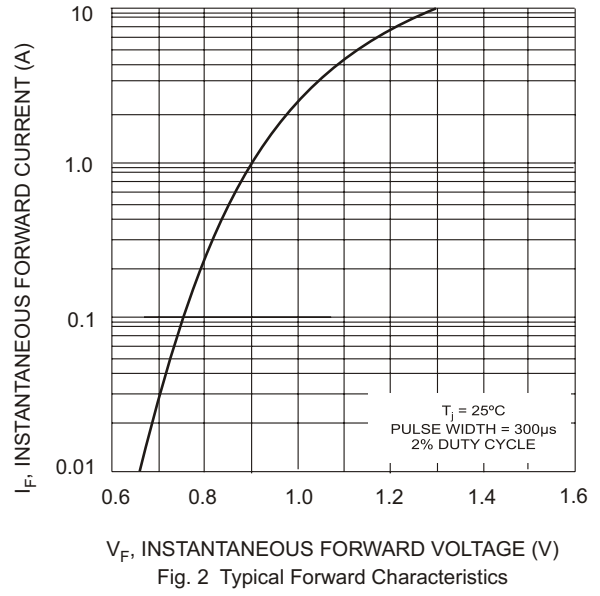
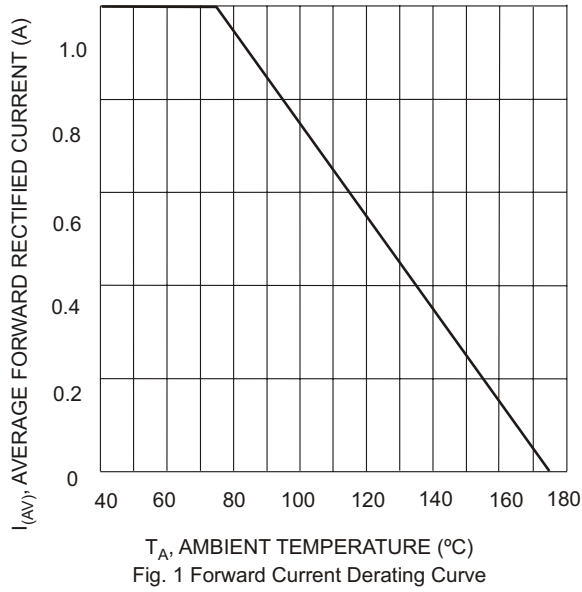
"L" Suffix Designates A-405 Package  
No Suffix Designates DO-41 Package

### Maximum Ratings and Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	1N4001 G/GL	1N4002 G/GL	1N4003 G/GL	1N4004 G/GL	1N4005 G/GL	1N4006 G/GL	1N4007 G/GL	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) @ T <sub>A</sub> = 75°C	I <sub>O</sub>	1.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	30							A
Forward Voltage @ I <sub>F</sub> = 1.0A	V <sub>FM</sub>	1.0							V
Peak Reverse Current at Rated DC Blocking Voltage @ T <sub>A</sub> = 25°C @ T <sub>A</sub> = 125°C	I <sub>RM</sub>	5.0 50							μA
Reverse Recovery Time (Note 3)	t <sub>rr</sub>	2.0							μs
Typical Junction Capacitance (Note 2)	C <sub>j</sub>	8.0							pF
Typical Thermal Resistance Junction to Ambient	R <sub>θJA</sub>	100							K/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +175							°C

- Notes:
1. Leads maintained at ambient temperature at a distance of 9.5mm from the case.
  2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
  3. Measured with I<sub>F</sub> = 0.5A, I<sub>R</sub> = -1A, I<sub>rr</sub> = 0.25A.



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Datasheets for electronics components.